RESPONSE UNDER 37 C.F.R. § 1.116 EXPEDITED PROCEDURE GROUP 1792 PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of Docket No: Q84452 Michel PUECH Group Art Unit: 1792 Appln. No.: 10/516,455 Confirmation No.: 2876 Examiner: Allan W. OLSEN Filed: December 3, 2004 METHOD AND DEVICE FOR SUBSTRATE ETCHING WITH VERY HIGH POWER For: INDUCTIVELY COUPLED PLASMA **RESPONSE UNDER 37 C.F.R. § 1.116 MAIL STOP AF** Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450 Sir: In response to the Office Action dated May 5, 2008, please consider the remarks as found on the accompanying pages. TABLE OF CONTENTS

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